

# The First International Symposium on Integrated Magnetics (iSIM 2023)

Sendai International Center, Sendai, Japan May 14-15, 2023

## FIRST ANNOUNCEMENT AND CALL FOR PAPERS FOR iSIM 2023

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### Welcome to iSIM 2023:

The First International Symposium on Integrated Magnetics (iSIM 2023) will be held in Sendai, Japan, on May 14-15, 2023, as a satellite symposium to the IEEE International Magnetics Conference, INTERMAG 2023. We expect that future iSIM symposiums will be held annually. The iSIM 2023 will be in-person only.

With the rapid progress in the research and development of integrated magnetic materials, devices, and microsystems, there are great opportunities for integrated magnetics in IoT, 5G, smartphones, biomedical applications, etc. We started the iSIM series to serve the fast-growing needs of Society by reaching out to other IEEE societies and industries. The technical scope of iSIM 2023 includes integrated magnetic materials, devices, and microsystems for: sensing, integrated circuits, power supply on chip (PwrSoP), power supply in package (PwrSiP), flexible electronics, etc.

We look forward to seeing you in Sendai and to a productive iSIM 2023!

The iSIM Organizing Committee.

**Abstract Submission:** <https://theisim.org/abstract-submission/>

**Registration:** Starts on February 5, 2022, with a modest registration fee.

### Important Dates:

January 1, 2023:	Abstract submission site open Student travel grant applications open
February 5, 2023:	Abstract submission site closed Registration open
February 19, 2023:	Authors' notification of acceptance status of abstracts Student travel grant notification
May 1, 2023:	Manuscript submission site open
May 14, 2023:	Symposium begins

More details on iSIM 2023 are available at <https://www.theiSIM.org>



Northeastern  
University

